ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	© Co	terial Compo pyright 2005. IPC, Bannoo nternational and Pan-Amer	kburn, Illinois	s. All rights reserv	tion with		parts, the	declaratio	n encompas	ses all lowe		rials for w	hich the	em is an assembly manufacturer has aration.		
1752-2 1.1 IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x							m Type * tribute	1	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat							
Supplier Information																
Company Name * Company Unique ID				Unique ID Authority			Response Date *			ponse Doci	ument ID					
Cypress Semiconductor CorpCYPRESS						2009	12-09									
Contact Name * Richard Oshiro	Title - Contact QA Engrg Director			Phone - Contact * 408/943-2102		Email - Contact * rgo@cypress.com			Duplicate Contact -> Authorized Representative							
Authorized Representative * Title - Representative			е	Phone - Representative *			Email - Representative *			Supplier Comments or URL for Additional Information						
Glorioso Lutrinia EH & S Manager Sr.				632 8128161			lge@cypress.com									
Requester Item Number		Mfr Item Number		Mfr Item Name	9	Effect	Effective Date Vers		Manufacturi	ng Site	Weight *	UOM	ı u	Init Type		
		TSOP II 44L							Cypress M	anufacturin	mg	E	ach			
Alternate Recommendation							Alternate	Item Comme	ents Packa	ts Package QTP # 063202						
Manufacturing Proce	ss In	formation														
Terminal Plating / Grid Array Material Termina			Terminal B	Base Alloy J-STD-02		SL Rating	Peak Process Body Tempe		Temperature	rature Max Time at Peak Tempe			erature Number of Reflow Cycles			
Nickel/Palladium/Gold (Ni/Pd/Au) CU Allo			CU Alloy	у 3					260 C	20 seco		conds 3				
Comments			-		1		1			•		l .				
Compliant to RoHS requ	uirem	ents														

Save the fields in Import fields from a Clear all of the Lock the fields on this **Export Data** Import Data Reset Form Lock Supplier Fields this form to a file file into this form fields on this form form to prevent changes **RoHS Material Composition Declaration Declaration Type *** Detailed Rohs Directive Rohs Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenvls (PBB). Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium 2002/95/EC Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply. 1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance * Accepted **RoHS Declaration *** Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. **Declaration Signature**

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of Measure	Tolerar	PPM
	Name		Material	Weight	Measure		Levei				Substance					-	+
+1 -1	Base material	+M -M	Lead frame	116.89	mg	+C -C	Supplier	Cu	+S	-\$	Cu	7440-50-8		113.86	mg		253,18
		_				+C -C	Supplier	Fe	+S	-S	Fe	7439-89-6		2.81	mg		6,238
						+C -C	Supplier	Zn	+S	-s	Zn	7440-66-6		0.14	mg		312
						+C -C	Supplier	Р	+S	-s	Р	7723-14-0		0.08	mg		182
+1 -1	External Plating	+M -M	Lead finish	1.21	mg	+C -C	Supplier	Ni	+S	-S	Ni	'7440-02-0		1.17	mg		2,611
		•			•	+C -C	Supplier	Pd	+S	-S	Pd	7440-05-3		0.02	mg		47
						+C -C	Supplier	Au	+S	-s	Au	7440-57-5		0.02	mg		47
+1 -1	Adhesive	+M -M	Die attach	2.06	mg	+C -C	Supplier	Ag	+S	-S	Ag	7440-22-4		1.65	mg		3,670
		•			•	+C -C	Supplier	Bismaleimide	+S	-S	Bismaleimide			0.19	mg		413
						+C -C	Supplier	Polymer	+S	-s	Polymer			0.1	mg		229
						+C -C	Supplier	Methacrylate	+S	-s	Methacrylate			0.04	mg		92
						+C -C	Supplier	Acrylate ester	+S	-s	Acrylate ester			0.04	mg		92
						+C -C	Supplier	Organic peroxide	+S	-s	Organic peroxide			0.04	mg		92
+1 -1	Circuit	+M -M	Die	28.88	mg	+C -C	Supplier	Si	+S	-S	Si	7440-21-3		28.88	mg		64,223
+1 -1	Interconnect	+M -M	Bonding wire	1.71	mg	+C -C	Supplier	Au	+S	-S	Au	7440-57-5		1.71	mg		3,791
+1 -1	Encapsulation	+M -M	Mold compound	298.96	mg	+C -C	Supplier	Epoxy Resin	+S	-S	Epoxy Resin			17.94	mg		39,887
				•	•	+C -C	Supplier	Phenol Resin	+S	-S	Phenol Resin			14.95	mg		33,239
						+C -C	Supplier	Silica	+S	-S	Silica	60676-86-0		266.07	mg		591,65